Electronic Version v1.1 Stylesheet Version v1.1

| SUBMISSION TYPE: | NEW ASSIGNMENT |
|-----------------------|----------------|
| NATURE OF CONVEYANCE: | ASSIGNMENT |

CONVEYING PARTY DATA

| Name | Execution Date |
|---------------|----------------|
| Dae Rae LEE | 08/20/2007 |
| Jung Wan RYU | 08/21/2007 |
| Dae Bong YANG | 08/21/2007 |
| Young Soo KIM | 08/21/2007 |
| Yang Ho KIM | 08/20/2007 |

RECEIVING PARTY DATA

| Name: | LG Electronics Inc. | |
|-----------------------------------|--------------------------------|--|
| Street Address: | 20, Yoido-dong, Youngdungpo-gu | |
| City: | Seoul | |
| State/Country: KOREA, REPUBLIC OF | | |

PROPERTY NUMBERS Total: 1

| Property Type | Number |
|---------------------|----------|
| Application Number: | 11648689 |

CORRESPONDENCE DATA

Fax Number: (703)205-8050

Correspondence will be sent via US Mail when the fax attempt is unsuccessful.

Phone: 703-205-8000

Email: Shonda.wilson@bskb.com

Correspondent Name: Birch, Stewart, Kolacsh & Birch, LLP

Address Line 1: PO Box 747

Address Line 4: Falls Church, VIRGINIA 22040-0747

| ATTORNEY DOCKET NUMBER: | 0465-1728PUS1 |
|-------------------------|--------------------|
| NAME OF SUBMITTER: | James T. Eller Jr. |

Total Attachments: 2

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PATENT REEL: 019836 FRAME: 0010

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PATENT REEL: 019836 FRAME: 0011

BIRCH, STEWART, KOLASCH & BIRCH, LLP

UNITED STATES PATENT RIGHTS, OR UNITED STATES PLUS ALL FOREIGN PATENT RIGHTS

ASSIGNMENT

11/648,689 Application No. Filed. January 03, 2007 insert Name(s) ***(Given Name FAMILY NAME (ALL CAPS))*** of inventor(s) WHEREAS, Dae Rae LEE; Jung Wan RYU; Dae Bong YANG; Young Boo KIM; and Yang Ho KIM (hereinafter designated as the underzigned) has (have) invented certain new and useful improvements in: Insert Title GAS RADIATION BURNER of Invention for which an application for Letters Patent of the United States of America has been executed by the undersigned (except in the case of a provisional application) on August 20, 2007 and August 21, 2007 and (Respectively) Insert Date of Signing of

Application Insert Name of Assignee Insert Address of Assigner

WHEREAS, LG Electronics Inc.

of 20, Yoldo-dong, Youngdungpo-gu

its heirs, successors, legal representatives and assigns (hereinafter designated as the Assignce) is desirous of acquiring the entire right, title and interest in and to said invention and in and to any Letters Patent(s) that may be granted therefor in the United States of America and

CHECK BOX IF APPROPRIATE x in any foreign constries.

NOW, THEREFORE, in consideration of the sum of Ten Dollars (\$10.00) to the undersigned in hand paid, the receipt of which is hereby acknowledged, and other good and valuable consideration, the undersigned has (have) sold, assigned and transferred, and by these presents does sell, assign and transfer unto said Assignee the full and exclusive right to the said invention in the United States of America, its territories, dependencies and possessions and the entire right, title and interest in and to any and all Letters Patent(s) which may be granted therefor in the United States of America, its territories, dependencies and possessions, and if the box above is designated, in any and all foreign countries:

and to any and all divisions, reissues, continuations, conversions and extensions thereof for the full term or terms for which the same may be granted.

The undersigned agree(s) to execute all papers necessary in connection with this application and any continuing, divisional, conversion or reissue applications thereof and also to execute separate assignments in connection with such applications as the Assignee may deem necessary or expedient.

The undersigned agree (s) to execute all papers necessary in connection with any interference which may be declared concerning this application or continuation, division, conversion or reissue thereof or letter Patent(s) or reissue patent issued thereon and to cooperate with the Assignee in every way possible in obtaining and producing evidence and proceeding with such interference.

The undersigned agree(s) to execute all papers and documents and to perform any act which may be necessary in connection with claims or provisions of the international Convention for the Protection of Industrial Property or similar agreements.

The undersigned agree(s) to perform all affirmative acts which may be necessary to obtain a grant of a valid United States of America patent(s) or a grant of a valid United States of America and any foreign patent(s) to the Assignce and to vest all rights therein hereby conveyed to said Assignce as fully and entirely as the same would have been held by the undersigned if this Assignment and sale had not been made.

The undersigned hereby authorize(s) and request(s) the Patent and Trademark Office Officials in the United States of America and in any foreign countries to issue any and all Letters Patents resulting from said application of any continuing, divisional conversion or reissue applications thereof to the said Assignce, as Assignee of the entire interest, and hisreby coverains that he has likely have the full right to convey the entire interest herein assigned, and that he has (they have) not executed, and will not execute, any agreement in conflict herewith.

The undersigned hereby grant(s) the law firm of Birch, Stewart, Kolasch & Birch, LLP the power to insert on this Assignment any further identification which may be necessary or desirable in order to comply with the rules of the U.S. Patent and Trademark Office for recordation of this document.

The undersigned hereby covenant(s) that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment.

in witness whereof, executed by the undersigned on the diffe(s) opposite the undersigned name(s).

| Date | , 03°. B. 1700C | Name of Inventor [5] UM M (signature) Dac Rec LEE |
|--------|-----------------|---|
| Ďate _ | 2007 8·21 | Name of Inventor |
| Date | 7009. 8. W | (Signature) hing Wan RYU Name of Inventor (Signature) Dae Hong YANG |
| Date _ | 2007.8.21 | Name of Inventor (Signature) Young Soo Kild |
| Date _ | 2009 . 8. 20 | Name of Inventor (signature) Yang He KiM |